

General Description

The CMSC7418A is designed to provide a high efficiency synchronous buck power stage with optimal layout and board space utilization. This device is well suited for use in compact DC/DC converter applications.

Features

- Low ON-resistance
- 100% EAS Guaranteed
- Surface Mount Package
- RoHS Compliant

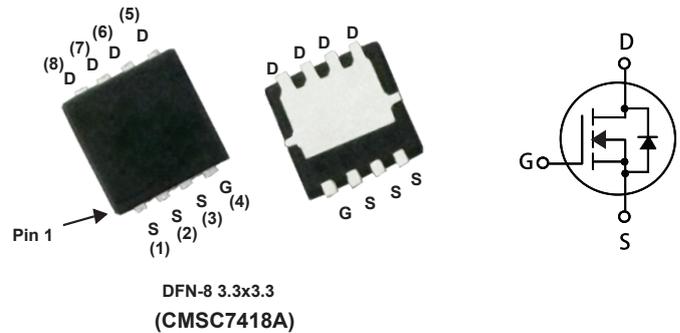
Product Summary

BVDSS	RDSON	ID
30V	1.9mΩ	50A

Applications

- Load switch, battery switch in portable devices

DFN-8 3.3x3 .3 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	50	A
$I_D@T_C=100^\circ C$	Continuous Drain Current	39	A
I_{DM}	Pulsed Drain Current	200	A
EAS	Single Pulse Avalanche Energy ¹	420	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	83	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient(Device on PCB)	---	60	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-case	---	1.8	$^\circ C/W$

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=30A$	---	1.5	1.9	m Ω
		$V_{GS}=4.5V, I_D=20A$	---	2.3	3	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	0.7	---	1.5	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=24V, V_{GS}=0V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=5V, I_D=20A$	---	53	---	S
R_g	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	---	3	---	Ω
Q_g	Total Gate Charge	$V_{DD}=15V, I_D=30A$ $V_{GS}=0$ to $4.5V$	---	22	---	nC
Q_{gs}	Gate-Source Charge		---	7	---	
Q_{gd}	Gate-Drain Charge		---	6.5	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=15V, V_{GS}=10V, R_G=1.6\Omega$ $I_D=30A$	---	6	---	ns
T_r	Rise Time		---	8	---	
$T_{d(off)}$	Turn-Off Delay Time		---	30	---	
T_f	Fall Time		---	5	---	
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, f=1\text{MHz}$	---	2400	---	pF
C_{oss}	Output Capacitance		---	1100	---	
C_{rss}	Reverse Transfer Capacitance		---	150	---	

Diode Characteristics

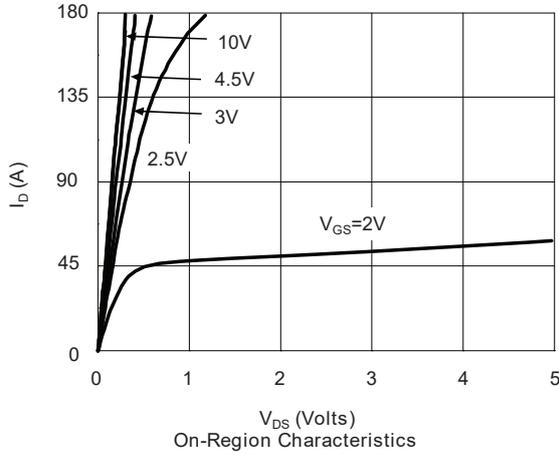
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Diode continuous forward current	$V_G=V_D=0V$, Force Current	---	---	50	A
$I_{S,pulse}$	Diode pulse current		---	---	200	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=20A, T_J=25^{\circ}\text{C}$	---	0.75	1	V

Notes:

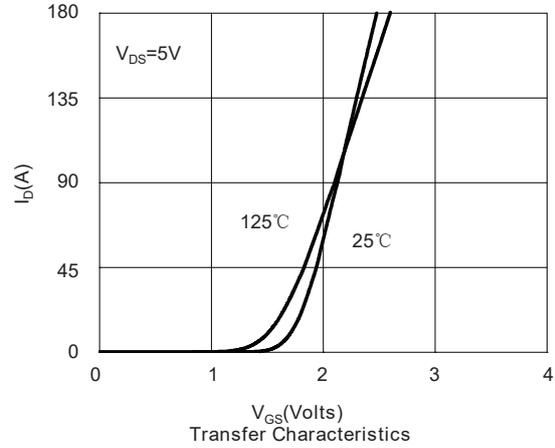
1.The EAS data shows Max. rating .The test condition is $V_{DS}=25V, V_{GS}=10V, L=0.5\text{mH}, I_{AS}=41A$.

This product has been designed and qualified for the consumer market.
Cmos assumes no liability for customers' product design or applications.
Cmos reserves the right to improve product design ,functions and reliability without notice.

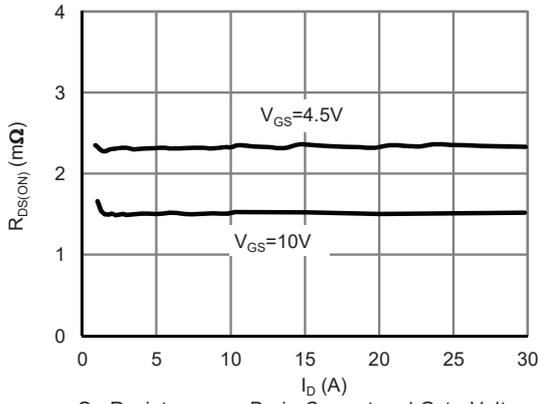
Typical Characteristics



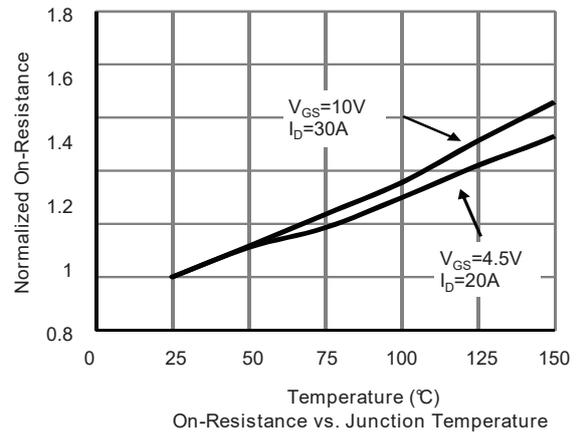
On-Region Characteristics



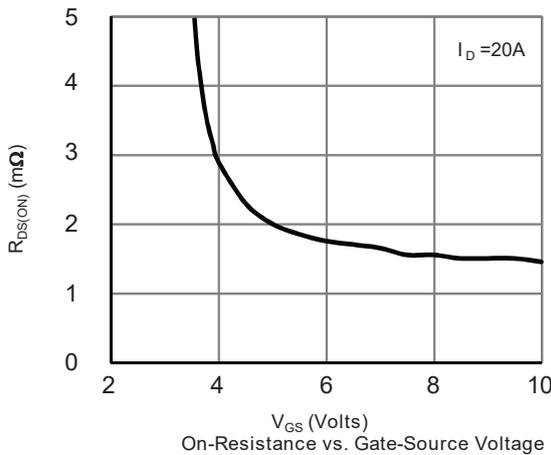
Transfer Characteristics



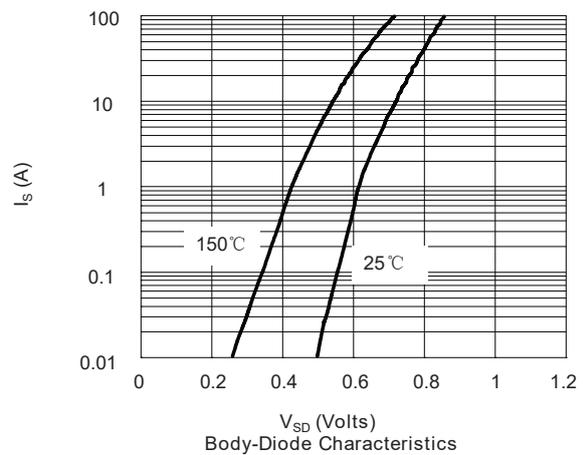
On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-Source Voltage



Body-Diode Characteristics

Typical Characteristics

